

MOSFET

$OptiMOS^{TM}5\ Power-Transistor,\ 80\ V$

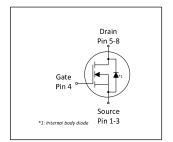
Features

- Optimized for Synchronous Rectification in server and desktop
- 100% avalanche testedSuperior thermal resistance
- N-channel
- Qualified according to JEDEC¹⁾ for target applications
 Pb-free lead plating; RoHS compliant
 Halogen-free according to IEC61249-2-21



Parameter	Value	Unit
V _{DS}	80	V
R _{DS(on),max}	2.6	mΩ
I_{D}	184	A
Q _{oss}	88	nC
Q _G (0V10V)	74	nC











Type / Ordering Code	Package	Marking	Related Links
BSC026N08NS5	PG-TDSON-8	026N08NS	-



Table of Contents

Description	1
Maximum ratings	3
Thermal characteristics	3
Electrical characteristics	1
Electrical characteristics diagrams	3
Package Outlines)
Revision History	1
Trademarks1	1
Disclaimer	1



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 **Maximum ratings**

5	0	Values				N
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current ¹⁾	I _D	-	-	184 116 23	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =50K/W ²⁾
Pulsed drain current ³⁾	I _{D,pulse}	-	-	736	Α	T _C =25 °C
Avalanche energy, single pulse ⁴⁾	E _{AS}	-	-	370	mJ	I_D =50 A, R_{GS} =25 Ω
Gate source voltage	V _{GS}	-20	-	20	V	-
Power dissipation	P _{tot}	-	-	156 2.5	W	$T_{\rm C}$ =25 °C $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =50 K/W ²⁾
Operating and storage temperature	T _j , T _{stg}	-55	-	150	°C	IEC climatic category; DIN IEC 68-1: 55/150/56

2 Thermal characteristics

Table 3 Thermal characteristics

Dovementer	Cumbal	Values			Unit	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case, bottom	R_{thJC}	-	0.5	0.8	K/W	-
Thermal resistance, junction - case, top	R _{thJC}	-	_	20	K/W	-
Device on PCB, 6 cm ² cooling area ²⁾	R_{thJA}	-	_	50	K/W	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature environmental conditions.

2) Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed in as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual

See Diagram 3 for more detailed information

⁴⁾ See Diagram 13 for more detailed information



3 Electrical characteristics at T_j =25 °C, unless otherwise specified

Table 4 **Static characteristics**

Barranatan	0		Values			
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	80	-	-	V	$V_{\rm GS}$ =0 V, $I_{\rm D}$ =1 mA
Gate threshold voltage	$V_{\rm GS(th)}$	2.2	3	3.8	V	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 115 \mu {\rm A}$
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1 100	μΑ	V _{DS} =80 V, V _{GS} =0 V, T _j =25 °C V _{DS} =80 V, V _{GS} =0 V, T _j =125 °C
Gate-source leakage current	I _{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	-	2.2 3.0	2.6 3.9	mΩ	V _{GS} =10 V, I _D =50 A V _{GS} =6 V, I _D =25 A
Gate resistance ¹⁾	R _G	-	1.9	2.9	Ω	-
Transconductance	g_{fs}	60	120	-	S	$ V_{DS} > 2 I_D R_{DS(on)max}, I_D = 50 A$

 Table 5
 Dynamic characteristics

Davamatav	Values			5	l lmi4	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance ¹⁾	C _{iss}	-	5200	6800	pF	V _{GS} =0 V, V _{DS} =40 V, f=1 MHz
Output capacitance ¹⁾	Coss	-	840	1100	pF	V _{GS} =0 V, V _{DS} =40 V, <i>f</i> =1 MHz
Reverse transfer capacitance ¹⁾	C _{rss}	-	38	66	pF	V _{GS} =0 V, V _{DS} =40 V, <i>f</i> =1 MHz
Turn-on delay time	$t_{\sf d(on)}$	-	18	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =3 Ω
Rise time	t _r	-	14	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =3 Ω
Turn-off delay time	$t_{ m d(off)}$	-	47	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =3 Ω
Fall time	t_{f}	-	16	-	ns	V_{DD} =40 V, V_{GS} =10 V, I_{D} =50 A, $R_{\text{G,ext}}$ =3 Ω

Gate charge characteristics²⁾ Table 6

Doromotor	S. mahal		Values		11:4	Nata / Tast Candition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q_{gs}	-	24	-	nC	V_{DD} =40 V, I_{D} =50 A, V_{GS} =0 to 10 V
Gate charge at threshold	$Q_{g(th)}$	-	14	-	nC	V_{DD} =40 V, I_{D} =50 A, V_{GS} =0 to 10 V
Gate to drain charge ¹⁾	$Q_{ m gd}$	-	16	23	nC	V_{DD} =40 V, I_{D} =50 A, V_{GS} =0 to 10 V
Switching charge	Q _{sw}	-	25	-	nC	V_{DD} =40 V, I_{D} =50 A, V_{GS} =0 to 10 V
Gate charge total ¹⁾	Q_{g}	-	74	92	nC	V _{DD} =40 V, I _D =50 A, V _{GS} =0 to 10 V
Gate plateau voltage	V _{plateau}	-	4.5	-	V	V _{DD} =40 V, I _D =50 A, V _{GS} =0 to 10 V
Gate charge total, sync. FET	Q _{g(sync)}	-	64	-	nC	V _{DS} =0.1 V, V _{GS} =0 to 10 V
Output charge ¹⁾	Qoss	-	88	117	nC	V _{DD} =40 V, V _{GS} =0 V

Defined by design. Not subject to production test.
See "Gate charge waveforms" for parameter definition

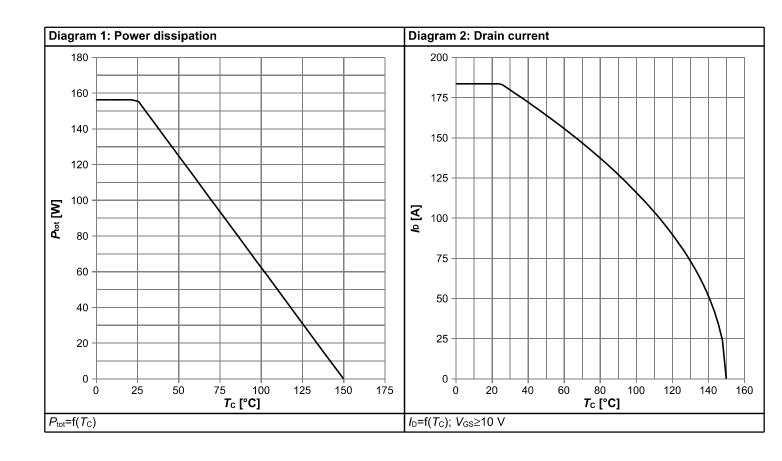


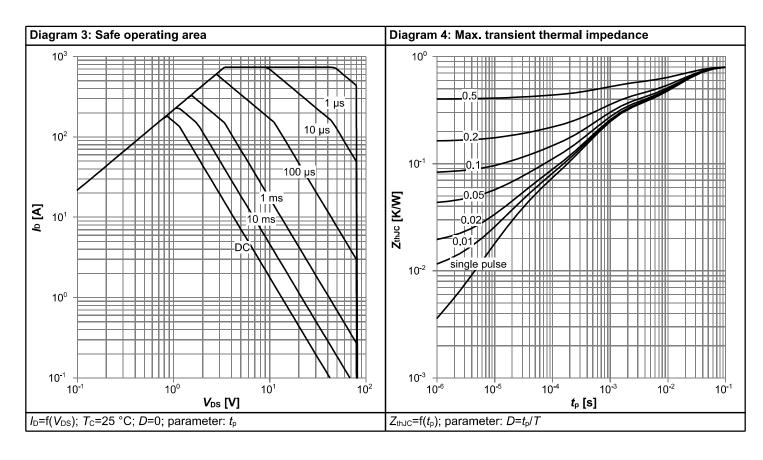
Table 7 Reverse diode

Parameter	Cymbal		Values			Nata / Task Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continuous forward current	Is	-	-	118	Α	T _C =25 °C
Diode pulse current	I _{S,pulse}	-	-	736	Α	T _C =25 °C
Diode forward voltage	V _{SD}	-	0.85	1.1	V	V _{GS} =0 V, I _F =50 A, T _j =25 °C
Reverse recovery time ¹⁾	t _{rr}	-	56	112	ns	V _R =40 V, I _F =50A, d <i>i</i> _F /d <i>t</i> =100 A/μs
Reverse recovery charge ¹⁾ Q _{rr}		-	92	184	nC	V _R =40 V, I _F =50A, di _F /dt=100 A/μs

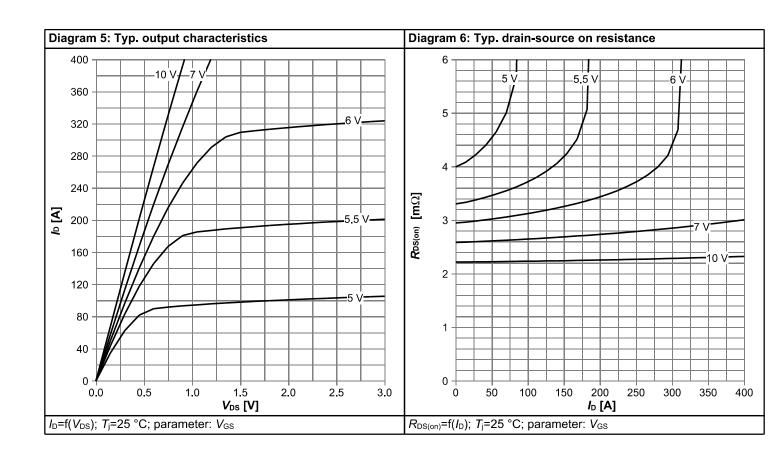


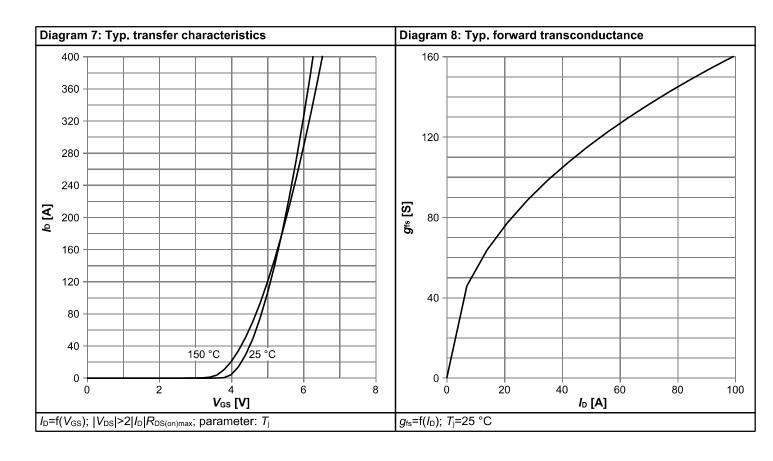
4 Electrical characteristics diagrams



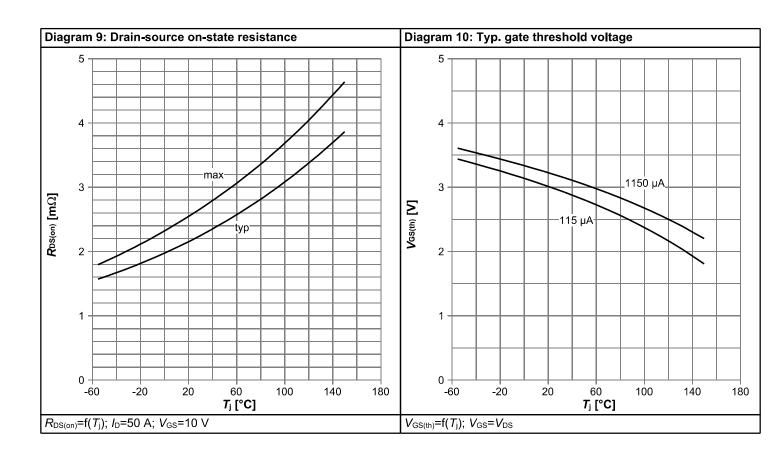


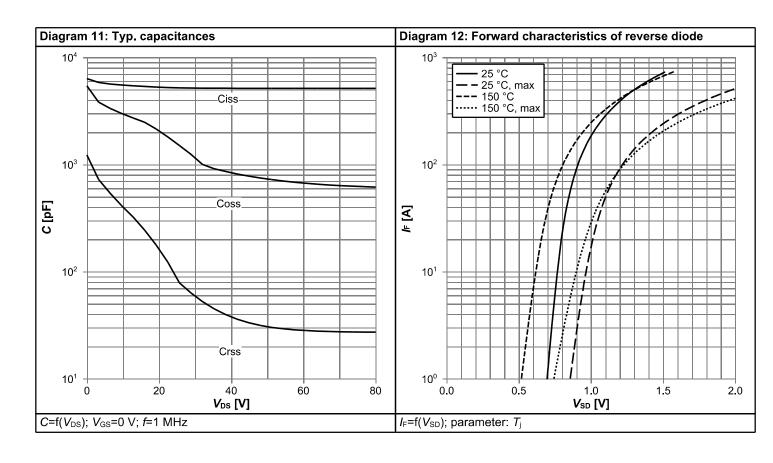




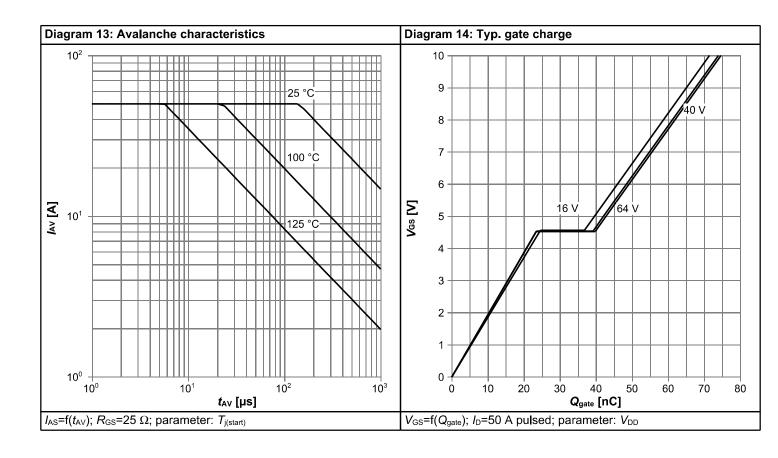


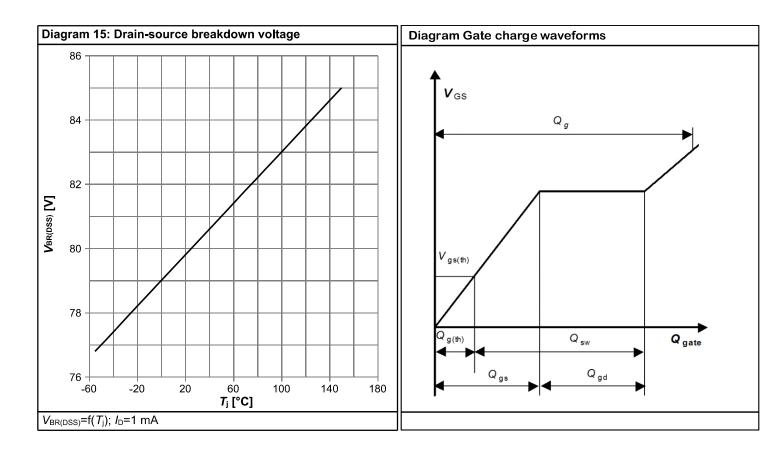






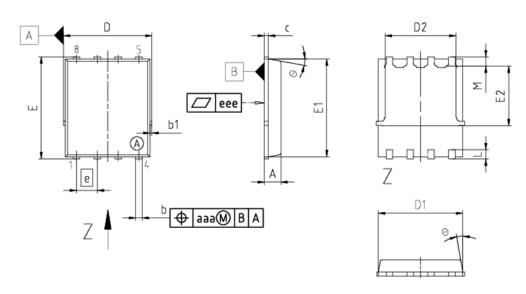








5 Package Outlines



DIM	MILLIM	MILLIMETERS						
DIM	MIN	MAX						
Α	0.90	1.10						
b	0.31	0.54						
b1	0.02	0.22						
С	0.15	0.35						
D	5.15	5.49						
D1	4.95	5.35						
D2	3.70	4.40						
E	5.95	6.35						
E1	5.70	6.10						
E2	3.40	3.80						
e	1.27							
N	8							
L	0.45	0.71						
М	0.45	0.75						
Θ	8.5°	12°						
aaa	0.:	25						
eee	0.08							

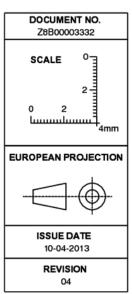


Figure 1 Outline PG-TDSON-8, dimensions in mm



Revision History

BSC026N08NS5

Revision: 2021-07-20, Rev. 2.2

Previous Revision

To Note the Medical Property of the Medical Property o					
Revision	ision Date Subjects (major changes since last revision)				
2.0	2014-12-18	Release of final version			
2.1	2015-08-31	Rev. 2.0			
2.2	2021-07-20	Update current rating			

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